Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	25	"6155915" "6368189" "6790763" "6852019"	US-PGPUB; USPAT	OR	OFF	2006/03/27 10:21
S1	107	((force pressure) same gradient)same (polish\$3 planariz\$4)	USPAT	OR	OFF	2006/03/27 10:20
S2	28	(polish\$ planariz\$6) with (magnet\$6 with bias\$3)	USPAT	OR	OFF	2005/03/31 09:13
S3	350	(polish\$ planariz\$6) with (magnet\$1)	USPAT	OR	OFF	2005/03/31 09:13
S4	342	S3 not S2	USPAT	OR	OFF	2005/03/31 09:13
S5	99	S4 and (wafer semiconductor)	USPAT	OR	OFF	2005/03/31 09:14
S6	0	"09912982"	USPAT	OR	OFF	2005/03/31 09:25
S7	1	"09/912982"	USPAT	OR	OFF	2005/03/31 09:26
<b>S8</b>	27	("4606151"   "5432395"   "5607341"   "5836807"   "6028669"   "6050878"   "6050882"   "6056632"   "6059638"   "6179956"   "6315634"   "6354928"   "6390901"   "6390905"   "6394882"   "6435948"   "6436828"   "6443821"   "6447368"   "6506105"   "6558232"   "6592434"   "6612903"   "6623343"   "6659850"   "6719615"   "6725120").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/04/04 17:09
S9	12172230	US- "5,607,341" US- "5,836,807" US- "6,354,928" B1 US- "6,390,901" B1 US- "6,390,905" B1 US- "6,394, 882" B1 US- "6,435,948" BI US- "6, 436,828" B1 US- "6,443,821" B1 US- "6,447,368" B1 US- "6,506,105" B1 US- "6,558,232" B1 US- "6,592, 434" B1 US- "6,61" "2,903" "82" US- "6,623,343" "82" US- "6,659, 850" "82" US- "6,719,615" B1	US-PGPUB; USPAT; USOCR	OR	OFF	2005/04/04 17:10
S10	12172230	US- "5,607,341" US- "5,836,807" US- "6,354,928" B1 US- "6,390,901" B1 US- "6,390,905" B1 US- "6,394, 882" B1 US- "6,435,948" BI US- "6, 436,828" B1 US- "6,443,821" B1 US- "6,447,368" B1 US- "6,506,105" B1 US- "6,558,232" B1 US- "6,592, 434" B1 US- "6,612,903" US- "6, 623,343" US- "6,659,850" US- "6, 719,615" B1	US-PGPUB; USPAT; USOCR	OR	OFF	2005/04/04 17:10

					, <del></del>	
S11	12172230	US- "5,607,341" US- "5,836,807" US- "6,354,928" B1 US- "6,390,901" B1 US- "6,390,905" B1 US- "6,394, 882" B1 US- "6,435,948" BI US- "6, 436,828" B1 US- "6,443,821" B1 US- "6,447,368" B1 US- "6,506,105" B1 US- "6,558,232" B1 US- "6,592, 434" B1 US- "6,612,903" US- "6, 623,343" US- "6,659,850" US- "6, 719,615" B14606151	US-PGPUB; USPAT; USOCR	OR	OFF	2005/04/04 17:10
S12	12172230	US- "5,607,341" US- "5,836,807" US- "6,354,928" B1 US- "6,390,901" B1 US- "6,390,905" B1 US- "6,394, 882" B1 US- "6,435,948" BI US- "6, 436,828" B1 US- "6,443,821" B1 US- "6,447,368" B1 US- "6,506,105" B1 US- "6,558,232" B1 US- "6,592, 434" B1 US- "6,612,903" US- "6, 623,343" US- "6,659,850" US- "6, 719,615" B1	US-PGPUB; USPAT; USOCR	OR	OFF	2005/04/04 17:11
S13	7436193	US- "5,607,341" US- "5,836,807" US- "6,354,928" B1 US- "6,390,901" B1 US- "6,390,905" B1 US- "6,394, 882" B1 US- "6,435,948" BI US- "6, 436,828" B1 US- "6,443,821" B1 US- "6,447,368" B1 US- "6,506,105" B1 US- "6,558,232" B1 US- "6,592, 434" B1 US- "6,612,903" US- "6, 623,343" US- "6,659,850" US- "6, 719,615" B1	USPAT	OR	OFF	2005/04/04 17:11
S14	18	"4606151"	USPAT	OR	OFF	2005/04/04 17:11
S15	17	(US- "5,607,341" US- "5,836,807" US- "6,354,928" B1 US- "6,390,901" B1 US- "6,390,905" B1 US- "6,394, 882" B1 US- "6,435,948" BI US- "6, 436,828" B1 US- "6,443,821" B1 US- "6,447,368" B1 US- "6,506,105" B1 US- "6,558,232" B1 US- "6,592, 434" B1 US- "6,659,850" US- "6, 623,343" US- "6,659,850" US- "6, 719,615" B1).pn.	USPAT	OR	OFF	2005/04/04 17:11
S16	1	"4606151".pn.	USPAT	OR	OFF	2005/04/04 17:12
S17	18	S15 S16	USPAT	OR	OFF	2005/04/04 17:18
S18	7434	"force gradient" "shear force"	USPAT	OR	OFF	2005/04/04 17:18
S19	593	S18 and (polish\$3 planariz\$6)	USPAT	OR	OFF	2005/04/04 17:19
S20	125	S19 and ((first and second)or (subsequent)) with (wafer substrate semiconductor)	USPAT	OR	OFF	2005/04/04 17:20
S21	10	gradient and macarthur-S\$.xa.	USPAT	OR	OFF	2005/04/05 14:21

		<del>,                                      </del>				
S22	3	("6594542" "6725120" "6612903"). pn.	USPAT	OR	OFF	2005/04/14 12:25
S23	1	"6594542".pn.	USPAT	OR	OFF	2005/04/14 12:25
S24	2	"6110239"	JPO; DERWENT	OR	ON	2005/04/14 13:42
S25	2	"06110239"	JPO; DERWENT	OR	ON	2005/04/14 13:40
S26	0	"61-10239"	JPO; DERWENT	OR	ON	2005/04/14 13:41
S27	0	"61102390"	JPO; DERWENT	OR	ON	2005/04/14 13:41
S28	0	"006110239"	JPO; DERWENT	OR	ON	2005/04/14 13:41
S29	0	"6110239".ipc.	JPO; DERWENT	OR	ON	2005/04/14 13:42
S30	0	"6110239".dw.	JPO; DERWENT	OR	ON	2005/04/14 13:42
S31	0	"06110239".dw.	JPO; DERWENT	OR	ON	2005/04/14 13:42
S32	4001	((force pressure) same (vary\$3 gradient differ\$3))same (polish\$3 planariz\$4)	US-PGPUB; USPAT	OR	OFF	2005/10/02 19:09
S33	971076	"2" and (wafer semiconductor substrate)	US-PGPUB; USPAT	OR	OFF	2005/10/02 19:08
S34	971443	"1" and (wafer semiconductor substrate)	US-PGPUB; USPAT	OR	OFF	2005/10/02 19:08
S35	2941	S32 and (wafer semiconductor substrate)	US-PGPUB; USPAT	OR	OFF	2005/10/02 19:08
S36	219	((force pressure) same (vary\$3 gradient differ\$3))same (polish\$3 planariz\$4)same (magnet\$6)	US-PGPUB; USPAT	OR	OFF	2005/10/02 19:24
S37	0	brown-nathan.in.	US-PGPUB; USPAT	OR	OFF	2005/10/02 19:26
S38	0	"nathan brown".in.	US-PGPUB; USPAT	OR	OFF	2005/10/02 19:25
S39	0	"nathan r. brown".in.	US-PGPUB; USPAT	OR	OFF	2005/10/02 19:25
S40	0	brown-nathanr.in.	US-PGPUB; USPAT	OR	OFF	2006/03/27 10:12
S41	0	"Nathan R. Brown"	US-PGPUB; USPAT	OR	OFF	2005/10/02 19:26
S42	0	brown-nathanr.in.	US-PGPUB; USPAT	OR	OFF	2005/10/02 19:26

S43	0	brown-nathan.in.	US-PGPUB; USPAT	OR	OFF	2005/10/02 19:27
S44	0	nathan-brown.in.	US-PGPUB; USPAT	OR	OFF	2005/10/02 19:29
S45	4	"6594542"	US-PGPUB; USPAT	OR	OFF	2005/10/02 19:29
S46	2	brown-nathan.in.	US-PGPUB; USPAT	OR	OFF	2006/03/27 10:13
S47	4	"6863771"	US-PGPUB; USPAT	OR	OFF	2006/03/27 10:13

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